

## **MOSFET**

## OptiMOS<sup>™</sup>-T2 Power Transistor, 60 V

#### **Features**

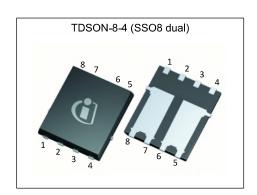
- · Dual N-channel, Normal Level
- · Fast switching MOSFETs
- 175°C operating temperature
- · Green product (RoHS compliant)
- · 100% Avalanche tested
- Optimized technology for drives applications
  Halogen-free according to IEC61249-2-21
  Superior thermal resistance

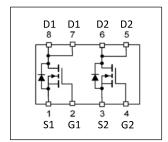
#### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

10000 1 11000 1 0110111101110101010							
Parameter	Value	Unit					
$V_{ t DS}$	60	V					
R <sub>DS(on),max</sub>	15.5	mΩ					
I <sub>D</sub>	42	Α					











Type / Ordering Code	Package	Marking	Related Links
BSC155N06ND	PG-TDSON-8-4	155N06ND	-

# OptiMOS<sup>TM</sup>-T2 Power Transistor, 60 V BSC155N06ND



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## OptiMOS<sup>™</sup>-T2 Power Transistor, 60 V BSC155N06ND



### **Maximum ratings**

at T<sub>A</sub>=25 °C, unless otherwise specified, one transistor active

Table 2 **Maximum ratings** 

Parameter	C: make al	Values			11:4	N / / T / O / Pitt
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	42	Α	V <sub>GS</sub> =10 V, T <sub>C</sub> =25 °C
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	168	Α	<i>T</i> <sub>A</sub> =25 °C
Avalanche energy, single pulse <sup>3)</sup>	E <sub>AS</sub>	-	-	40	mJ	$I_{\rm D}$ =10 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	$V_{\mathrm{GS}}$	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	50	W	<i>T</i> <sub>C</sub> =25 °C
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

#### Thermal characteristics 2

Thermal characteristics Table 3

Davamatar	Symbol		Values		Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.		Unit	Note / Test Condition	
Thermal resistance, junction - case, bottom	R <sub>thJC</sub>	_	-	3	°C/W	-	
Device on PCB, 6 cm² cooling area <sup>4)</sup>	$R_{thJA}$	-	-	60	°C/W	-	
Device on PCB, minimal footprint <sup>5)</sup>	R <sub>thJA</sub>	-	-	100	°C/W	-	

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>3)</sup> See Diagram 13 for more detailed information
<sup>4)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

<sup>5)</sup> device mounted on a minimum pad (one layer, 70 µm thick)

## OptiMOS<sup>™</sup>-T2 Power Transistor, 60 V BSC155N06ND



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

Davamatav	Cymph ol		Values		I I mid	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	60	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	V <sub>GS(th)</sub>	2.0	3.0	4.0	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =20 μA	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μA	V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	-	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	12.9	15.5	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =17 A	

 Table 5
 Dynamic characteristics

Parameter	Cymah al	Values		11	Note / Took Considition	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	1730	2250	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Output capacitance <sup>1)</sup>	Coss	-	380	490	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	15	30	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	11	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =11 $\Omega$
Rise time	t <sub>r</sub>	_	2	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =11 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	19	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =11 $\Omega$
Fall time	t <sub>f</sub>	_	9	_	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =11 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	Cymph al		Values		Limit	Note / Took Condition
	Symbol	Min.		Unit	Note / Test Condition	
Gate to source charge <sup>1)</sup>	Q <sub>gs</sub>	-	9	12	nC	V <sub>DD</sub> =30 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 10 V
Gate to drain charge <sup>1)</sup>	$Q_{\mathrm{gd}}$	-	2.0	4	nC	V <sub>DD</sub> =30 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 10 V
Gate charge total <sup>1)</sup>	$Q_{\rm g}$	-	21	29	nC	V <sub>DD</sub> =30 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 10 V
Gate plateau voltage	V <sub>plateau</sub>	-	5.3	_	V	V <sub>DD</sub> =30 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 10 V

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

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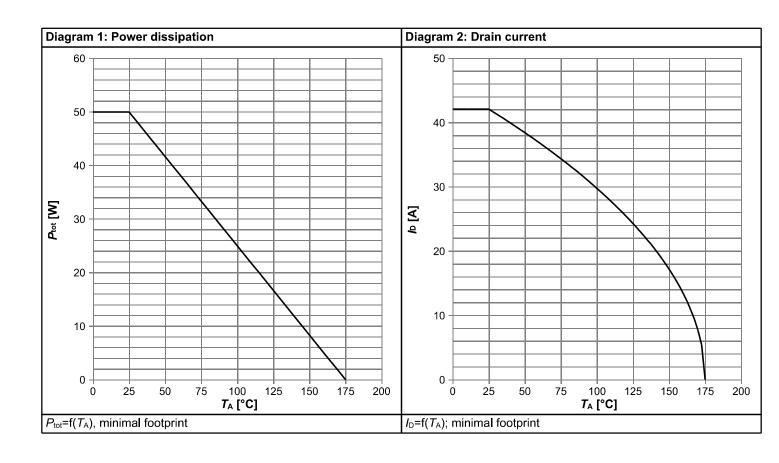


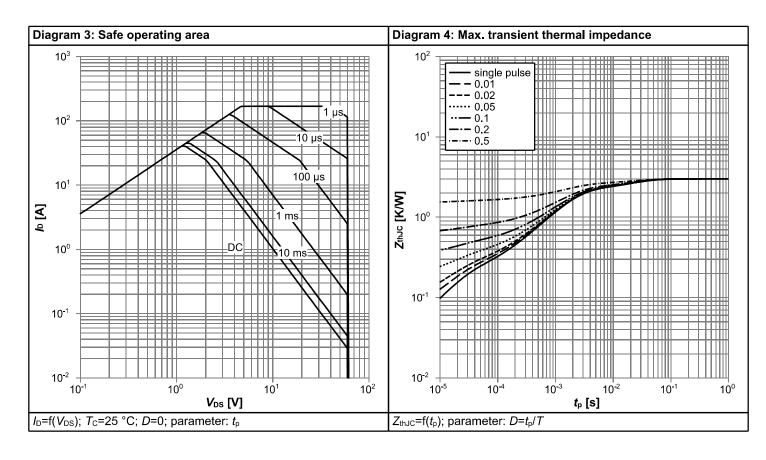
### Table 7 Reverse diode

Parameter	Complete and	Values			11	Note / Total Constitution
	Symbol	Min.	Typ. Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	34	Α	T <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	168	Α	T <sub>C</sub> =25 °C
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.91	1.1	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =17 A, T <sub>j</sub> =25 °C
Reverse recovery time	<i>t</i> <sub>rr</sub>	-	35	-	ns	V <sub>R</sub> =15 V, I <sub>F</sub> =9 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs
Reverse recovery charge	Qrr	-	35	-	nC	$V_{R}$ =15 V, $I_{F}$ =9 A, $di_{F}/dt$ =100 A/ $\mu$ s

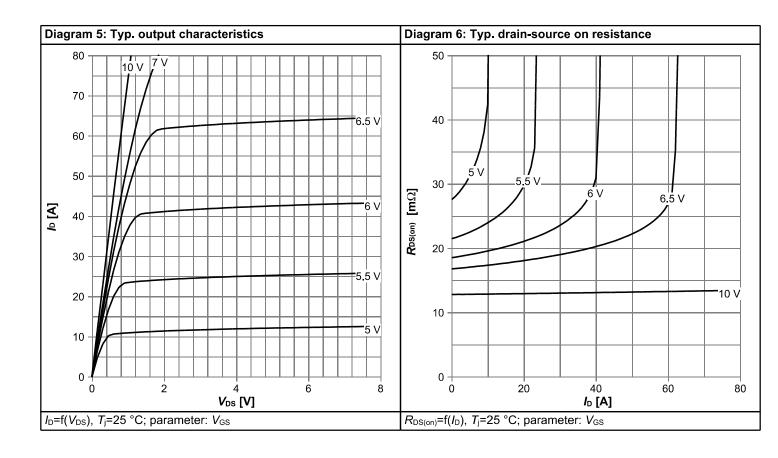


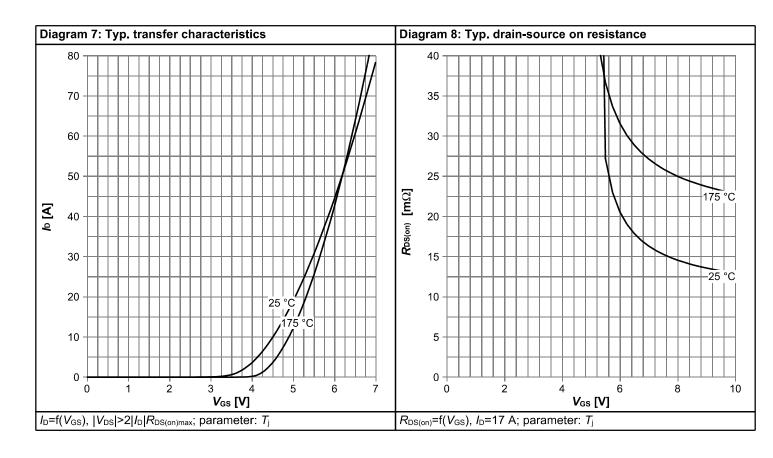
# 4 Electrical characteristics diagrams



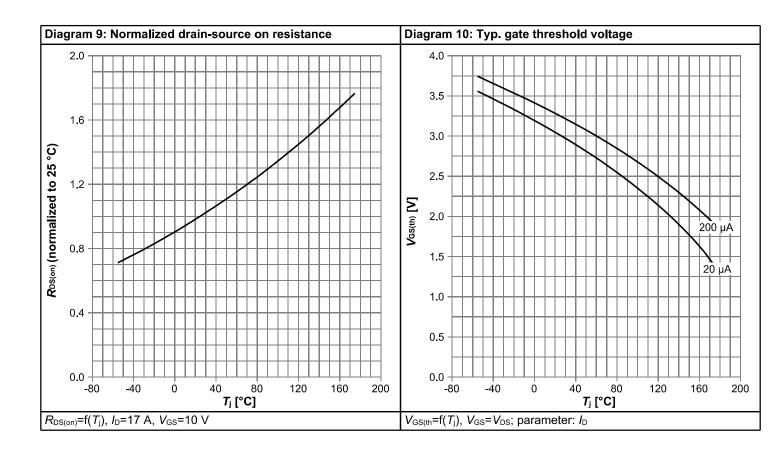


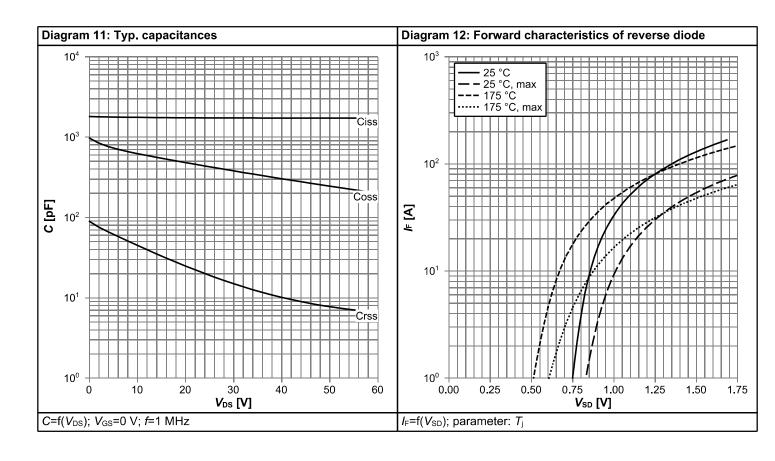




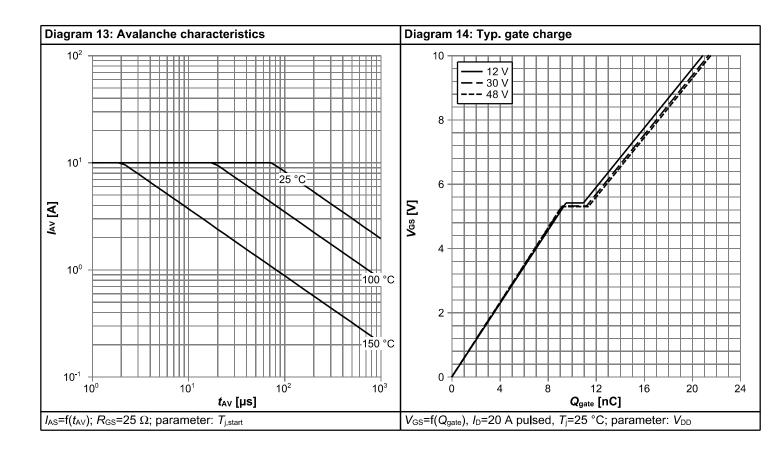


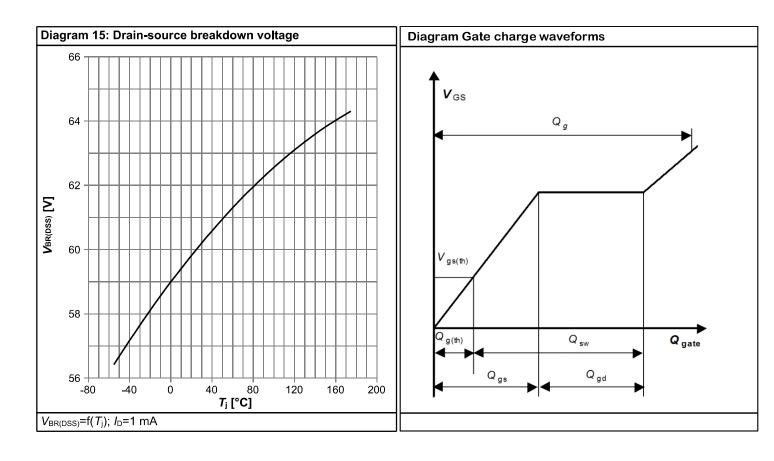






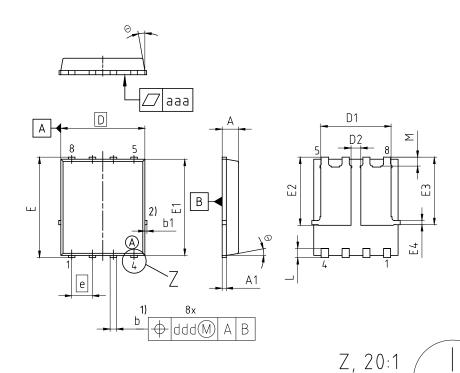








# 5 Package Outlines



1) EXCLUDE MOLD FLASH

2) REMOVAL ON MOLD GATE, INTRUSION 0.1 mm PROTRUSION 0.1 mm

ALL METAL SURFACES ARE PLATED EXCEPT AREA OF CUT

DIMENSIONS	MILLIM	ETERS			
DIMENSIONS	MIN.	MAX.			
Α	0.90	1.10			
A1	0.15	0.35			
b	0.34	0.54			
b1	0.02	0.22			
D	4.95	5.35			
D1	4.20	4.40			
D2	0.50	0.70			
E	5.95	6.35			
E1	5.70	6.10			
E2	4.075	4.275			
E3	4.035	4.235			
E4	0.15	0.35			
е	1.27				
L	0.45	0.65			
M	0.45	0.65			
Θ	8.5° 11.5°				
aaa	0.05				
ddd	0.	10			

DOCUMENT NO. Z8B00189767				
REVISION 01				
SCALE 5:1				
0 1 2 3 4mm Luuluuluuluul				
EUROPEAN PROJECTION				
ISSUE DATE 31.07.2018				

MOLD FLASH ALONG

SIDE OF LEADS

Figure 1 Outline PG-TDSON-8-4, dimensions in mm

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#### **Revision History**

BSC155N06ND

Revision: 2021-06-28, Rev. 2.1

Previous Revision

	The field of the field in						
Revision	Revision Date Subjects (major changes since last revision)						
2.0	2018-12-11	Release of final version					
2.1	2021-06-28	Update current rating and footnotes					

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